

4V Drive Nch + Pch MOSFET

SH8M12

● Structure

Silicon N-channel MOSFET/
Silicon P-channel MOSFET

● Features

- 1) Low on-resistance.
- 2) High power package(SOP8).
- 3) Low voltage drive(4V drive).

● Application

Switching

● Packaging specifications

Type	Package	Taping
	Code	TB
	Basic ordering unit (pieces)	2500
SH8M12		○

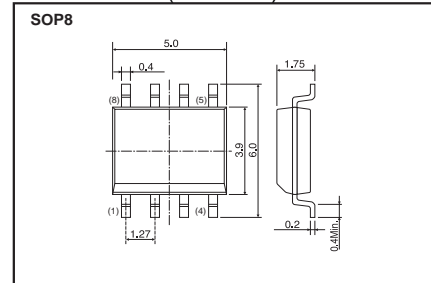
● Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits		Unit	
		Tr1 : N-ch	Tr2 : P-ch		
Drain-source voltage	V_{DSS}	30	-30	V	
Gate-source voltage	V_{GSS}	± 20	± 20	V	
Drain current	Continuous	I_D	± 5	± 4.5	A
	Pulsed	I_{DP} *1	± 20	± 18	A
Source current (Body Diode)	Continuous	I_S	1.6	-1.6	A
	Pulsed	I_{sp} *1	20	-18	A
Power dissipation	P_D *2	2.0		W / TOTAL	
		1.4		W / ELEMENT	
Channel temperature	Tch	150		°C	
Range of storage temperature	Tstg	-55 to +150		°C	

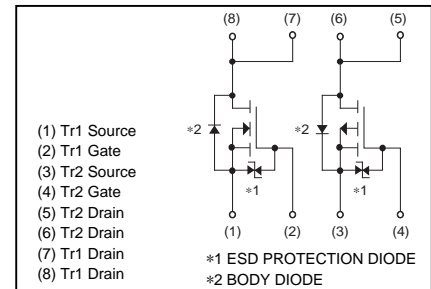
*1 $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

*2 Mounted on a ceramic board.

● Dimensions (Unit : mm)



● Inner circuit



● **Electrical characteristics** (Ta = 25°C)

<Tr1(Nch)>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	±10	μA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	30	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	$V_{DS}=30V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1.0	-	2.5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)}^*$	-	30	42	mΩ	$I_D=5A, V_{GS}=10V$
		-	40	56		$I_D=5A, V_{GS}=4.5V$
		-	45	63		$I_D=5A, V_{GS}=4V$
Forward transfer admittance	$ Y_{fs} ^*$	2.5	-	-	S	$V_{DS}=10V, I_D=5A$
Input capacitance	C_{iss}	-	250	-	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	-	90	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	-	45	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	6	-	ns	$I_D=2.5A, V_{DD}=15V$
Rise time	t_r^*	-	27	-	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}^*$	-	26	-	ns	$R_L=6\Omega$
Fall time	t_f^*	-	5	-	ns	$R_G=10\Omega$
Total gate charge	Q_g^*	-	4.0	-	nC	$I_D=5A, V_{DD}=15V$
Gate-source charge	Q_{gs}^*	-	1.2	-	nC	$V_{GS}=5V$
Gate-drain charge	Q_{gd}^*	-	1.2	-	nC	

*Pulsed

● **Body diode characteristics** (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	-	-	1.2	V	$I_S=5A, V_{GS}=0V$

*Pulsed

● **Electrical characteristics** (Ta = 25°C)

<Tr2(Pch)>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	±10	μA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	-30	-	-	V	$I_D=-1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}		-	-1	μA	$V_{DS}=-30V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	-1.0	-	-2.5	V	$V_{DS}=-10V, I_D=-1mA$
Static drain-source on-state resistance	$R_{DS(on)}^*$	-	40	56	mΩ	$I_D=-4.5A, V_{GS}=-10V$
		-	55	77		$I_D=-2.5A, V_{GS}=-4.5V$
		-	60	84		$I_D=-2.5A, V_{GS}=-4.0V$
Forward transfer admittance	$ Y_{fs} ^*$	3.5	-	-	S	$V_{DS}=-10V, I_D=-4.5A$
Input capacitance	C_{iss}	-	800	-	pF	$V_{DS}=-10V$
Output capacitance	C_{oss}	-	120	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	-	110	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	7	-	ns	$I_D=-2.5A, V_{DD}=-15V$
Rise time	t_r^*	-	15	-	ns	$V_{GS}=-10V$
Turn-off delay time	$t_{d(off)}^*$	-	70	-	ns	$R_L=6\Omega$
Fall time	t_f^*	-	50	-	ns	$R_G=10\Omega$
Total gate charge	Q_g^*	-	8.0	-	nC	$I_D=-4.5A, V_{DD}=-15V$
Gate-source charge	Q_{gs}^*	-	2.5	-	nC	$V_{GS}=-5V$
Gate-drain charge	Q_{gd}^*	-	3.0	-	nC	

*Pulsed

● **Body diode characteristics** (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	-	-	-1.2	V	$I_S=-4.5A, V_{GS}=0V$

*Pulsed

●Electrical characteristic curves (Ta=25°C)

<Tr.1(Nch)>

Fig.1 Typical Output Characteristics(I)

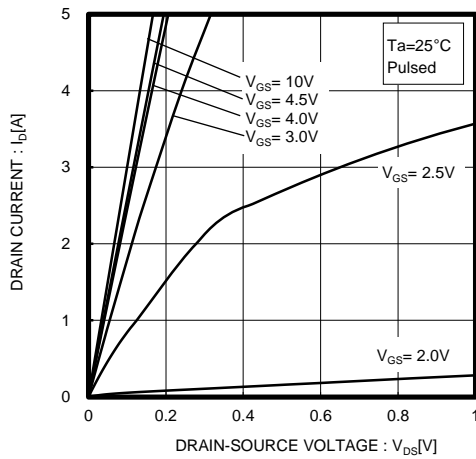


Fig.2 Typical Output Characteristics(II)

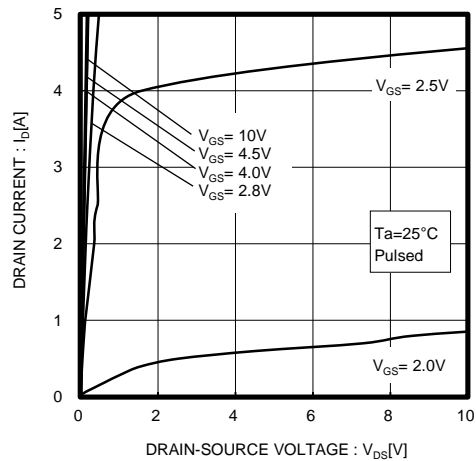


Fig.3 Typical Transfer Characteristics

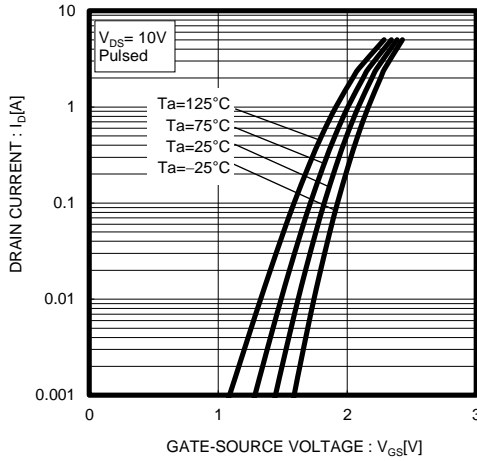


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

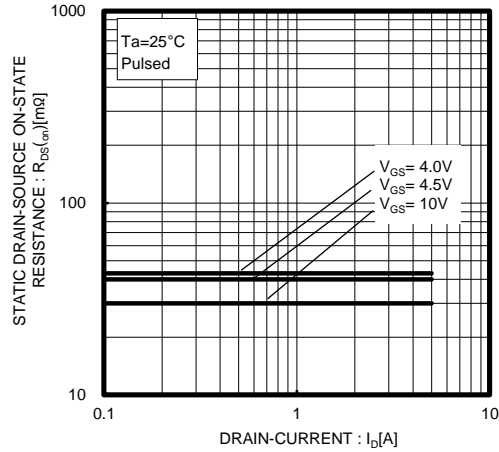


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

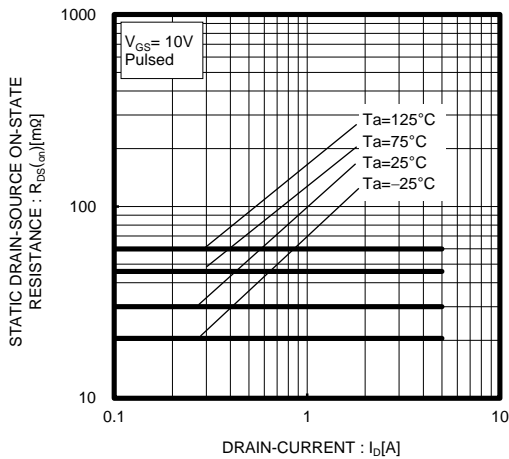


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(III)

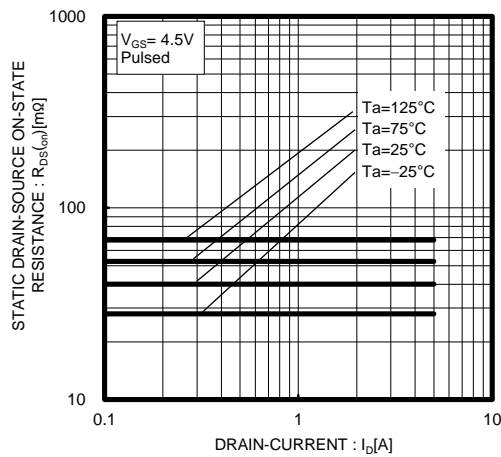


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (IV)

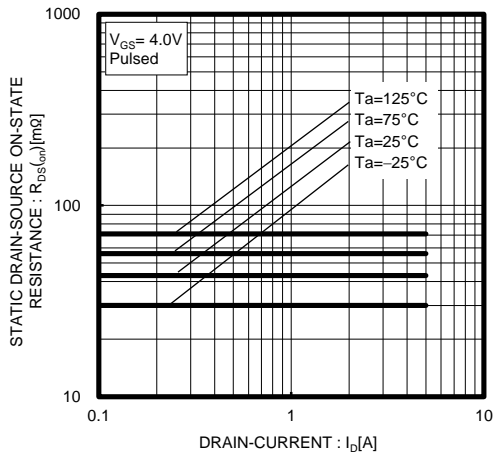


Fig.8 Forward Transfer Admittance vs. Drain Current

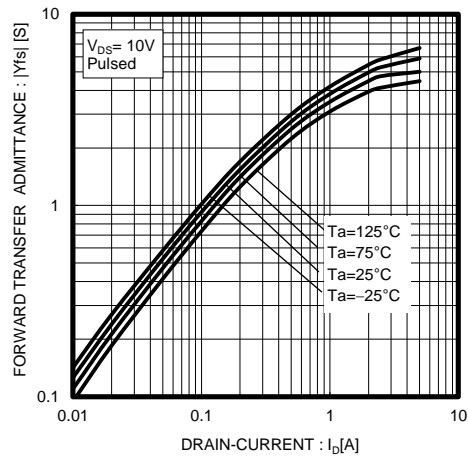


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

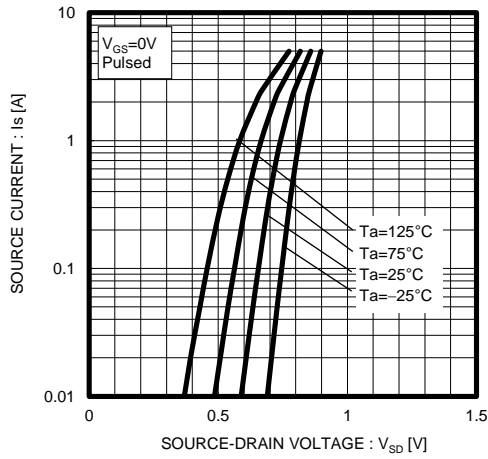


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

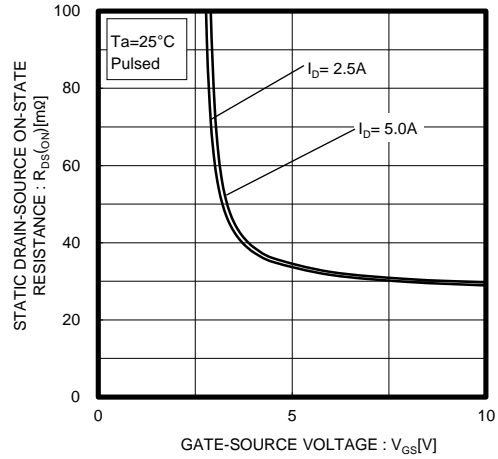


Fig.11 Switching Characteristics

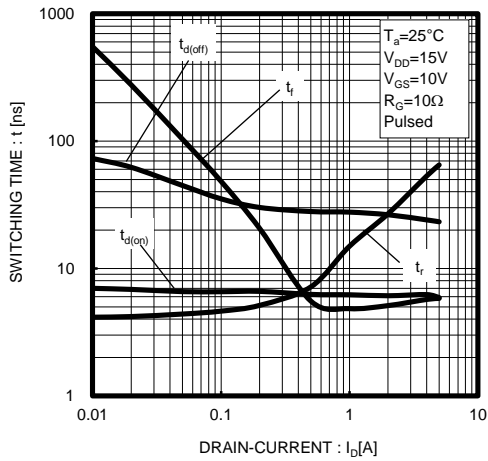


Fig.12 Dynamic Input Characteristics

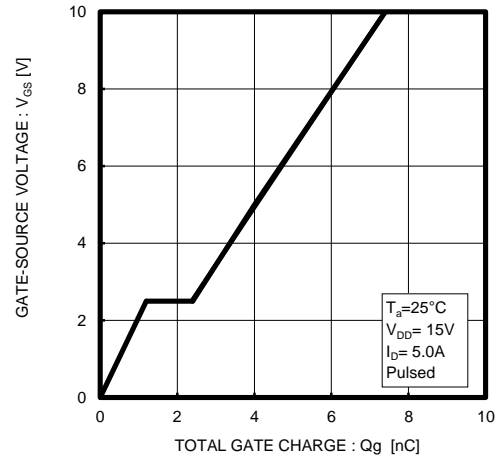


Fig.13 Typical Capacitance vs. Drain-Source Voltage

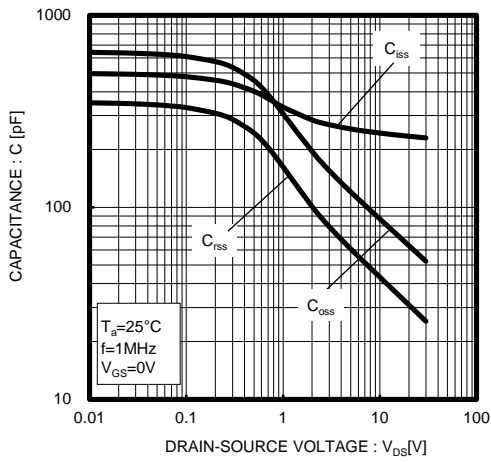


Fig.14 Maximum Safe Operating Area

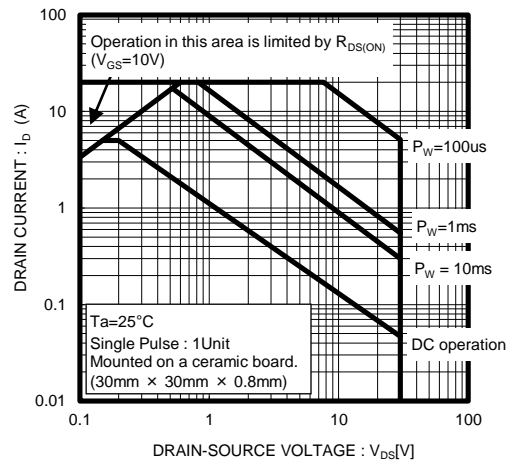
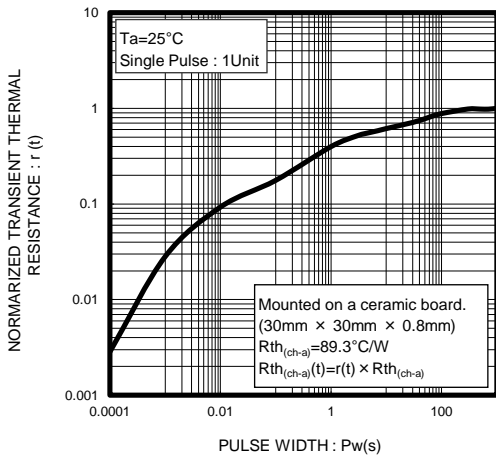


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width



<Tr.2(Pch)>

Fig.1 Typical Output Characteristics (I)

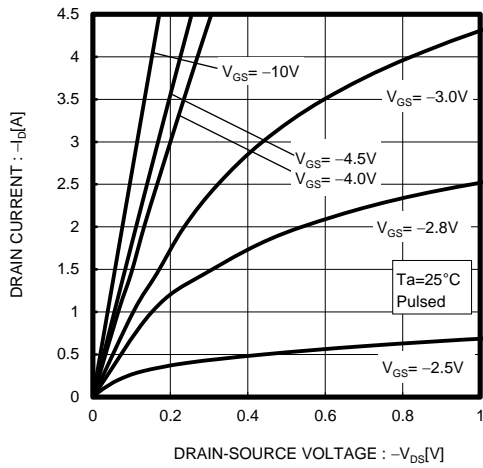


Fig.2 Typical Output Characteristics (II)

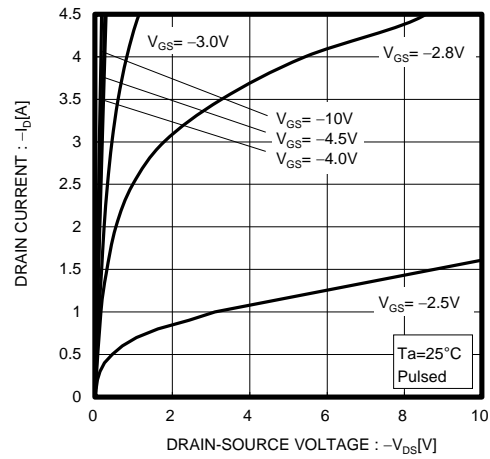


Fig.3 Typical Transfer Characteristics

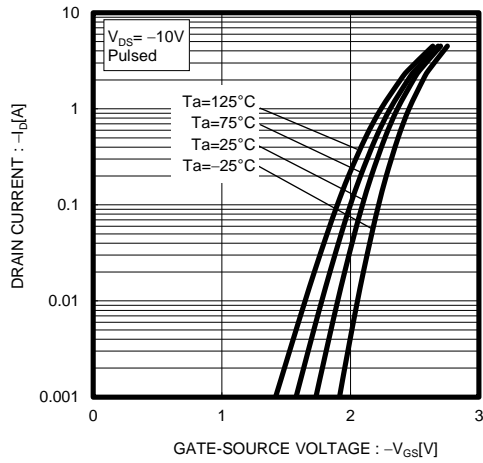


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

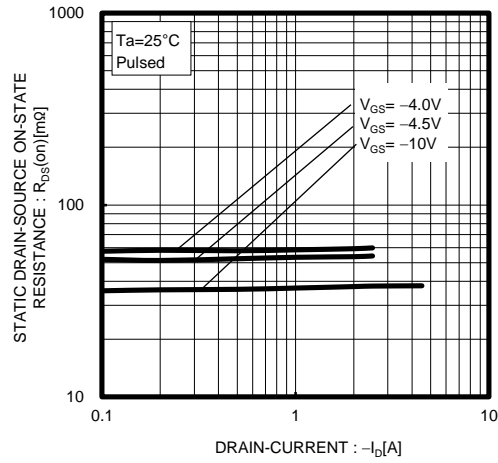


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

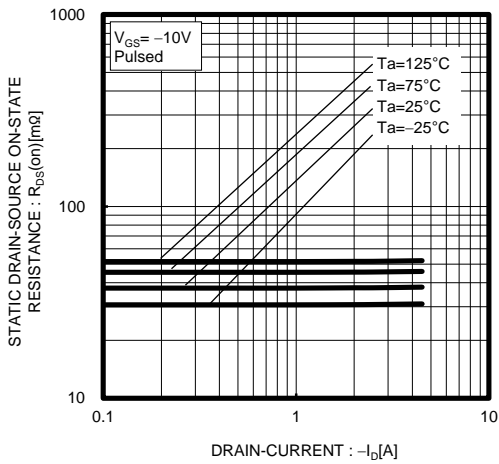


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (III)

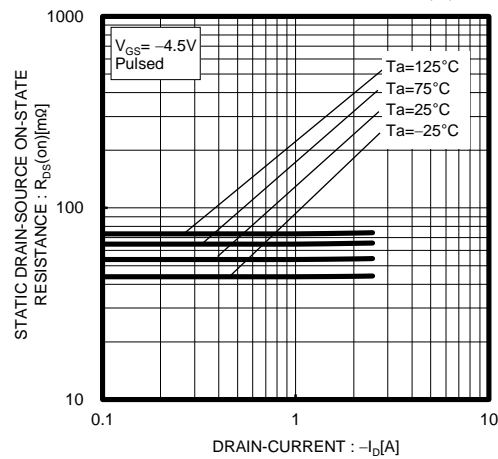


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)

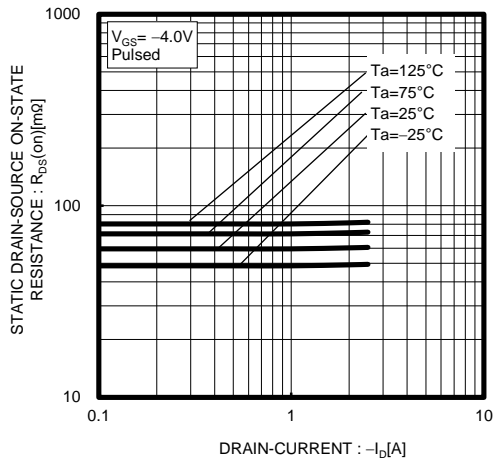


Fig.8 Forward Transfer Admittance vs. Drain Current

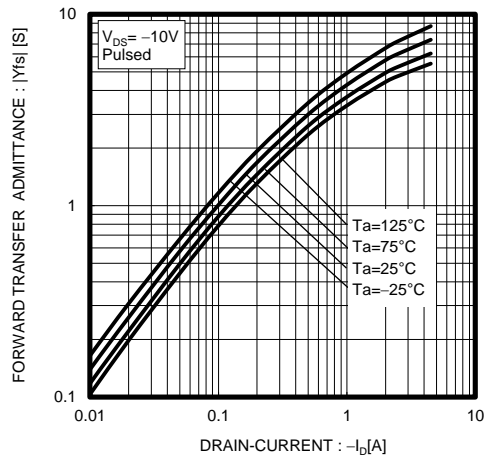


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

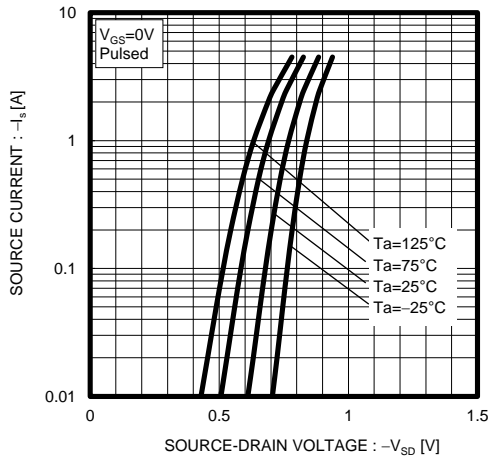


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

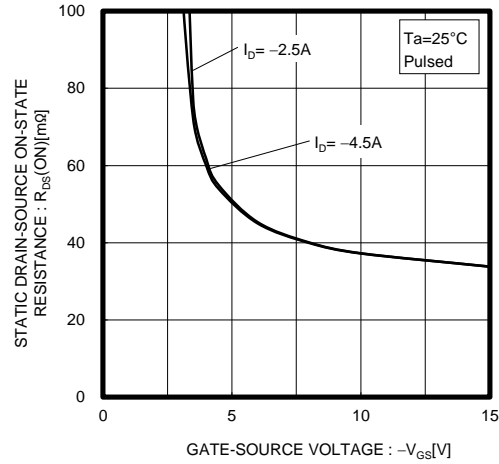


Fig.11 Switching Characteristics

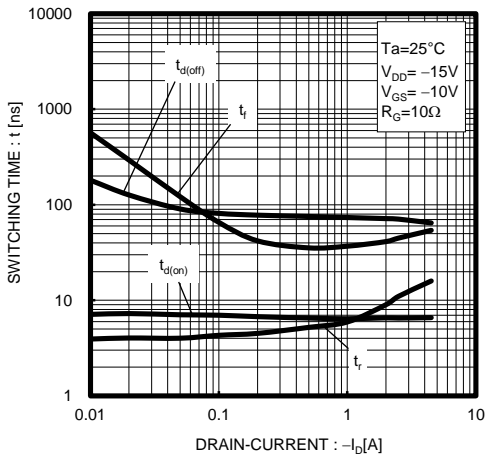


Fig.12 Dynamic Input Characteristics

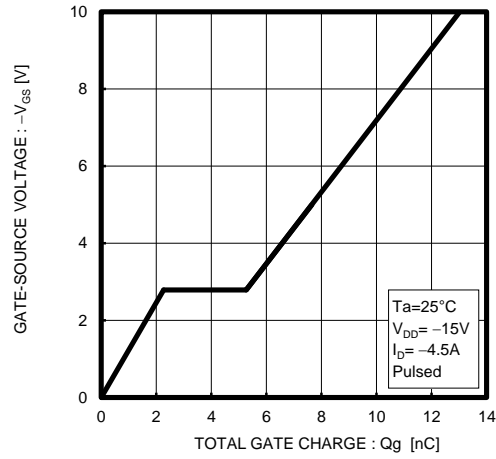


Fig.13 Typical Capacitance vs. Drain-Source Voltage

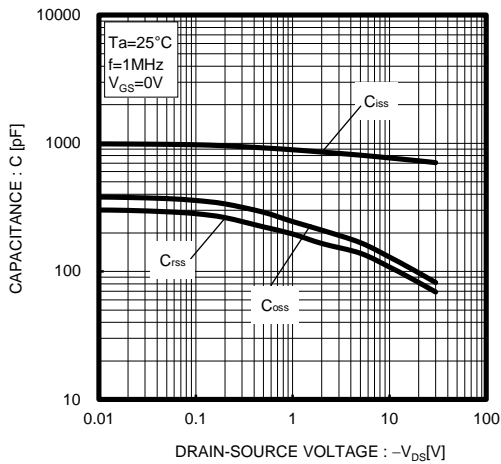


Fig.14 Maximum Safe Operating Area

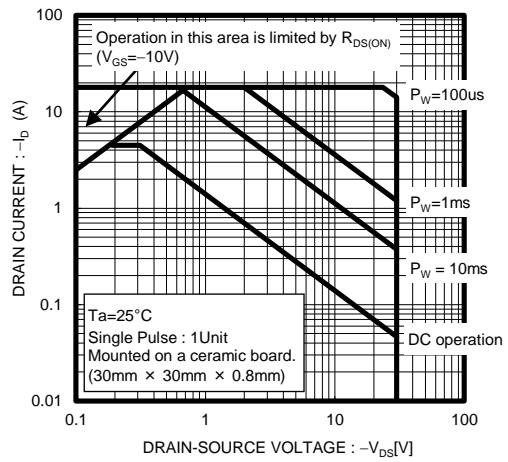
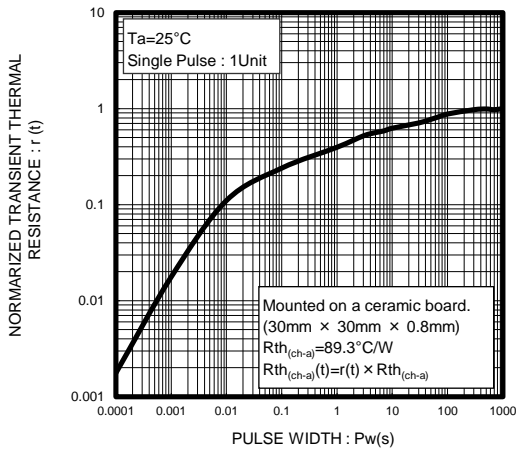


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width



● Measurement circuits

<Tr1(Nch)>

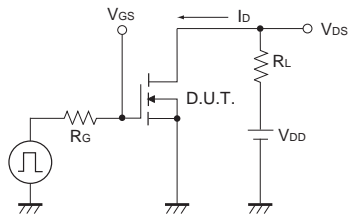


Fig.1-1 Switching Time Measurement Circuit

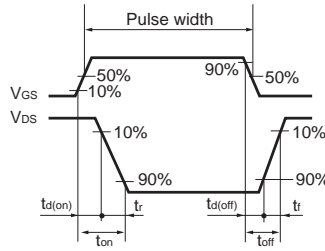


Fig.1-2 Switching Waveforms

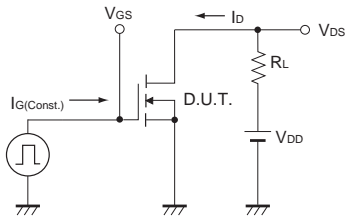


Fig.2-1 Gate Charge Measurement Circuit

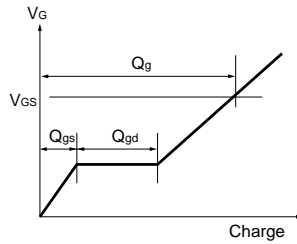


Fig.2-2 Gate Charge Waveform

<Tr2(Pch)>

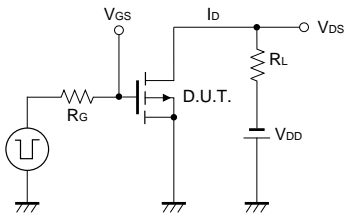


Fig.3-1 Switching Time Measurement Circuit

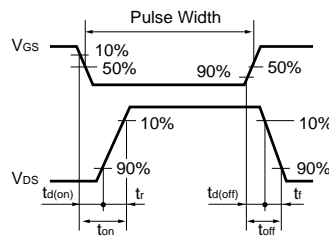


Fig.3-2 Switching Waveforms

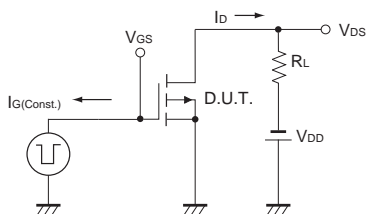


Fig.4-1 Gate Charge Measurement Circuit

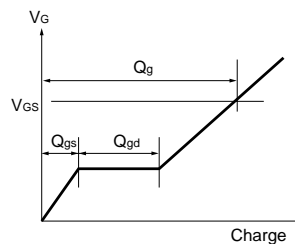


Fig.4-2 Gate Charge Waveform

● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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